

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT6708575

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	TASSIE ANDERSEN	05/05/2021
	SHURONG LIANG	05/06/2021
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	APPLIED MATERIALS, INC.	
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<b>City:</b>	SANTA CLARA	
<b>State/Country:</b>	CALIFORNIA	
<b>Postal Code:</b>	95054	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	17307813
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>	(508)898-2020	
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<b>ATTORNEY DOCKET NUMBER:</b>	44019681US01	
<b>NAME OF SUBMITTER:</b>	ROBERT C. FRAME	
<b>SIGNATURE:</b>	/Robert C. Frame/	
<b>DATE SIGNED:</b>	05/13/2021	
<b>Total Attachments: 4</b>		
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source=44019681US01-Assignment#page3.tif		
source=44019681US01-Assignment#page4.tif		

**ASSIGNMENT**

**WHEREAS**, the undersigned, to wit:

**Tassie Andersen**  
**Shurong Liang**

(Hereinafter collectively **ASSIGNOR**), have/has made a certain new and useful invention as set forth in an application for United States Letters Patent, entitled:

**Angled Etch For Surface Smoothing**

(X only one):

- (A) ☐ which was executed concurrently herewith and is being filed herewith in the United States Patent and Trademark Office;
- (B) ☐ which was executed on \_\_\_\_\_, 20\_\_\_\_, and is being filed herewith in the United States Patent and Trademark Office;
- (C) ☒ which was filed as **US Patent Appln. No. 17/307,813** filed on **May 4, 2021**.

**AND WHEREAS**, Applied Materials, Inc. (hereinafter **ASSIGNEE**), a corporation organized and existing under the laws of the state of California, and having its principal place of business at 3050 Bowers Avenue, Santa Clara, California 95054-3299, is desirous of acquiring the entire right, title, and interest in and to said invention and any and all patents that may be obtained therefore, and in and to said application and any and all patents that may issue therefrom;

**NOW, THEREFORE**, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, **ASSIGNOR** does hereby sell, assign, transfer, and set over unto said **ASSIGNEE**, its successors, assigns, and legal representatives, all right, title, and interest in and to said invention throughout the world, and any and all patents of the United States and foreign countries that may be obtained therefor, and in and to said application, including any and all continuations, continuations-in-part, divisionals, reissues, re-examinations, substitutions, and extensions thereof, and any and all patents of the United States and foreign countries that may issue therefrom, such right, title, and interest including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in the name of said **ASSIGNEE**, its successors, assigns, and legal representatives throughout the world, including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention, and all rights to register said invention in appropriate registries;

**ASSIGNOR** also does hereby covenant that it has the full right to convey the entire right, title, and interest herein assigned, and that it has not and will not execute any agreement in conflict herewith;

**ASSIGNOR** also does hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States on said invention or resulting from said application, including any continuations, continuations-in-part, divisions, reissues, re-examinations, substitutions, and extensions thereof, to said **ASSIGNEE**, its successors, assigns, and legal representatives as the **ASSIGNEE** of the entire right, title, and interest herein assigned;

**ASSIGNOR** also does hereby agree to, at any time, upon request, without further or additional consideration, but at the expense of said **ASSIGNEE**, its successors, assigns, or legal representatives, execute and deliver any and all papers, make all rightful oaths, and do all lawful acts that may be necessary or desirable to perfect the entire right, title, and interest here assigned in said **ASSIGNEE**, its successors, assigns, and legal representatives, and generally do everything possible to vest the entire right, title and interest herein assigned in said **ASSIGNEE**, its successors, assigns, and legal representatives;

**ASSIGNOR** also does hereby agree to, at any time, upon request, without further or additional consideration, but at the expense of said **ASSIGNEE**, its successors, assigns, or legal representatives, execute and deliver any and all papers, make all rightful oaths, and do all lawful acts that may be necessary or desirable to make application for and obtain any and all continuations, continuations-in-part, divisions, reissues, re-examinations, substitutions, and extensions of said application, or any application on said invention, or any patent issuing therefor or therefrom;

**ASSIGNOR** also does hereby agree to, at any time, upon request, without further or additional consideration but at the expense of said **ASSIGNEE**, its successors, assigns, and legal representatives, communicate to said **ASSIGNEE**, its successors, assigns, and legal representatives, any known facts relating to said invention or said application or any patent issuing therefor or therefrom, and testify as to the same in any interference or other litigation proceeding when requested to do so, and aid said **ASSIGNEE**, its successors, assigns, and legal representatives, in obtaining and enforcing property protection for said invention in all countries;

**ASSIGNOR** also does hereby grant the Legal Department of Varian Semiconductor Equipment Associates, Inc., at the address shown above, the power to insert on this assignment any further information, including, but not limited to application number(s) and filing date(s), which may be necessary or desirable in order to comply with any rule or request of the United States Patent and Trademark Office for the purposes of recording this document.

**ASSIGNOR** also does now hereby execute this document on the date(s) indicated below:

I have hereunto set my hand and seal this 5th day of May, 2021.

*Tassie Andersen*

Name: **Tassie Andersen**


I have hereunto set my hand and seal this \_\_\_\_ day of \_\_\_\_\_, 2021.

Name: **Shurong Liang**

I have hereunto set my hand and seal this \_\_\_\_\_ day of \_\_\_\_\_, 2021.

\_\_\_\_\_  
Name: **Tassie Andersen**

I have hereunto set my hand and seal this 6th day of May, 2021.

  
\_\_\_\_\_  
Name: **Shurong Liang**